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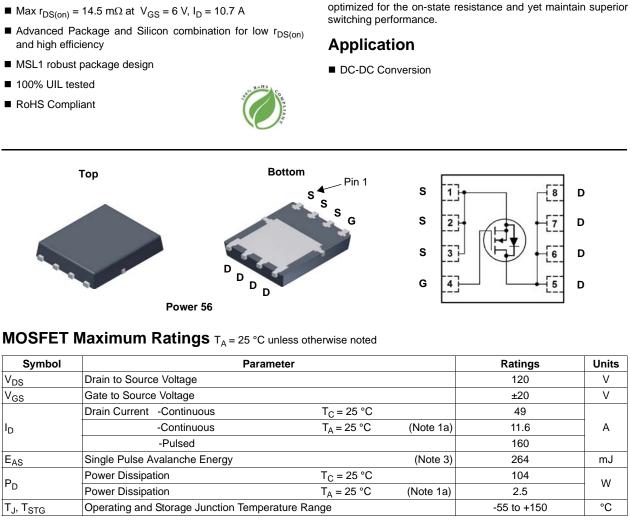


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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N-Channel Shielded Gate PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that

incorporates Shielded Gate technology. This process has been

Thermal Characteristics

FAIRCHILD

FDMS86201

Features

120 V, 49 A, 11.5 mΩ

Shielded Gate MOSFET Technology

• Max $r_{DS(on)}$ = 11.5 m Ω at V_{GS} = 10 V, I_D = 11.6 A

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.2	°C/W
Rein	Thermal Resistance, Junction to Ambient	(Note 1a)	50	°C/w

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86201	FDMS86201	Power 56	13 "	12 mm	3000 units

D

D

D

D

Units

V

V

А

mJ

W

°C

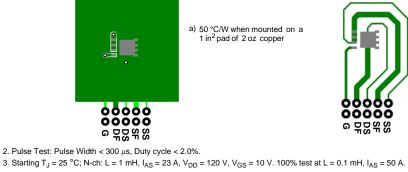
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FDMS86201 N	
N-Channel	
Shielded (
V-Channel Shielded Gate PowerTrench[®]	
)
MOSFET	

Symbol	Parameter	Test Conditions		Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	120			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		95		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 96 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2.0	2.6	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 11.6 A		9.6	11.5	
		V _{GS} = 6 V, I _D = 10.7 A		11.8	14.5	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 11.6 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		15.7	21.5	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 11.6 A		39		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			2056	2735	pF
C _{oss}	Output Capacitance	V _{DS} = 60 V, V _{GS} = 0 V, f = 1 MHz		322	430	pF
C _{rss}	Reverse Transfer Capacitance			15	25	pF
R _g	Gate Resistance			1.2		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			13	24	ns
t _r	Rise Time	V _{DD} = 60 V, I _D = 11.6 A,		7.7	16	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		27	44	ns
t _f	Fall Time	1 – – – – – – – – – – – – – – – – – – –		7.1	15	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		32	46	nC
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V} \text{V}_{DD} = 60 \text{ V},$		18	26	nC
Q _{gs}	Gate to Source Charge	I _D = 11.6 A		8.1		nC
	Gate to Drain "Miller" Charge			7.1		nC

V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2 A$	(Note 2)	0.69	1.2	- V
		$V_{GS} = 0 V, I_{S} = 11.6 A$	(Note 2)	0.78	1.3	
t _{rr}	Reverse Recovery Time	I _F = 11.6 A, di/dt = 100 A/μs		66	106	ns
Q _{rr}	Reverse Recovery Charge			88	140	nC

Notes: 1. R_{8JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.

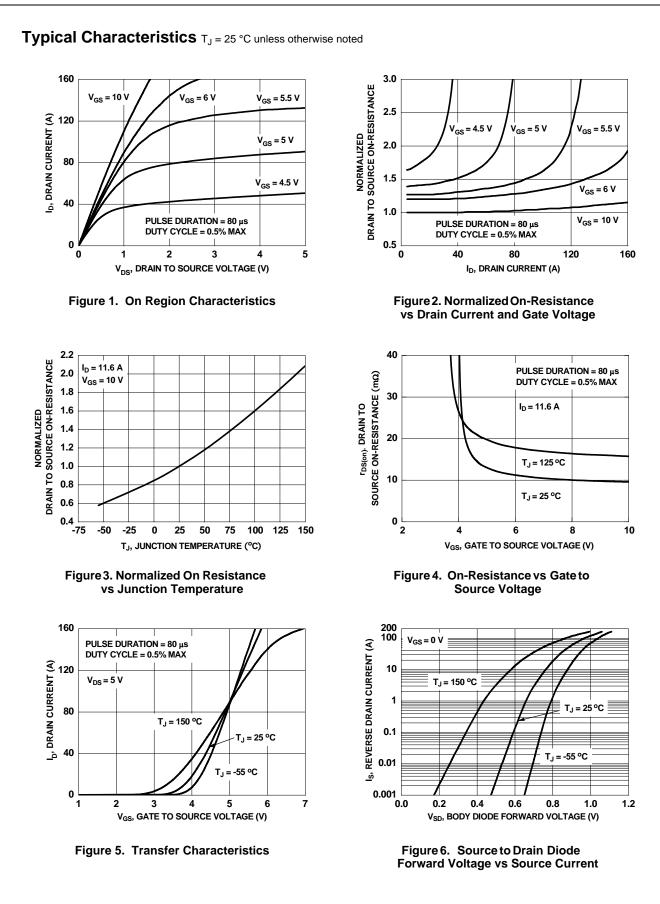


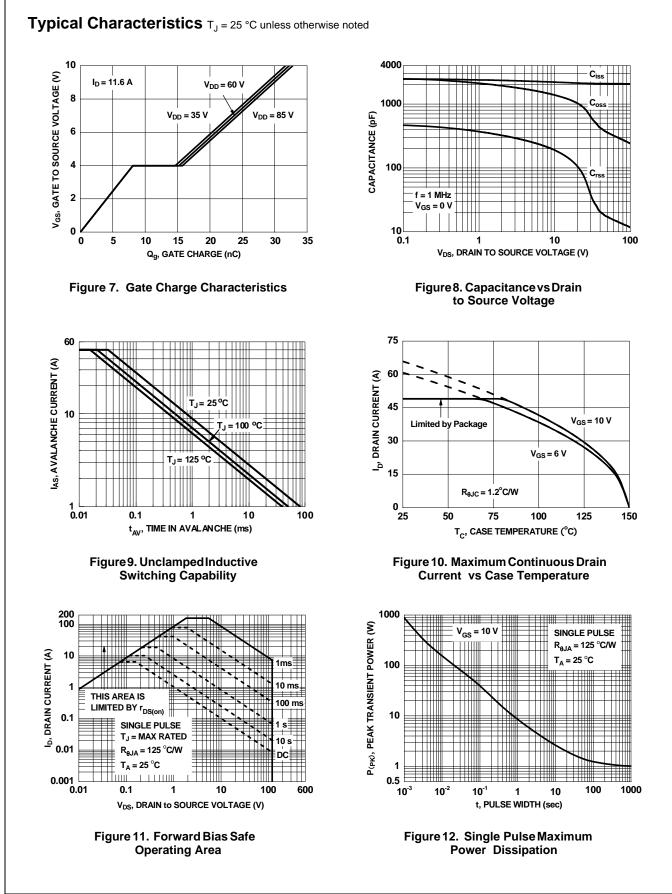
a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper



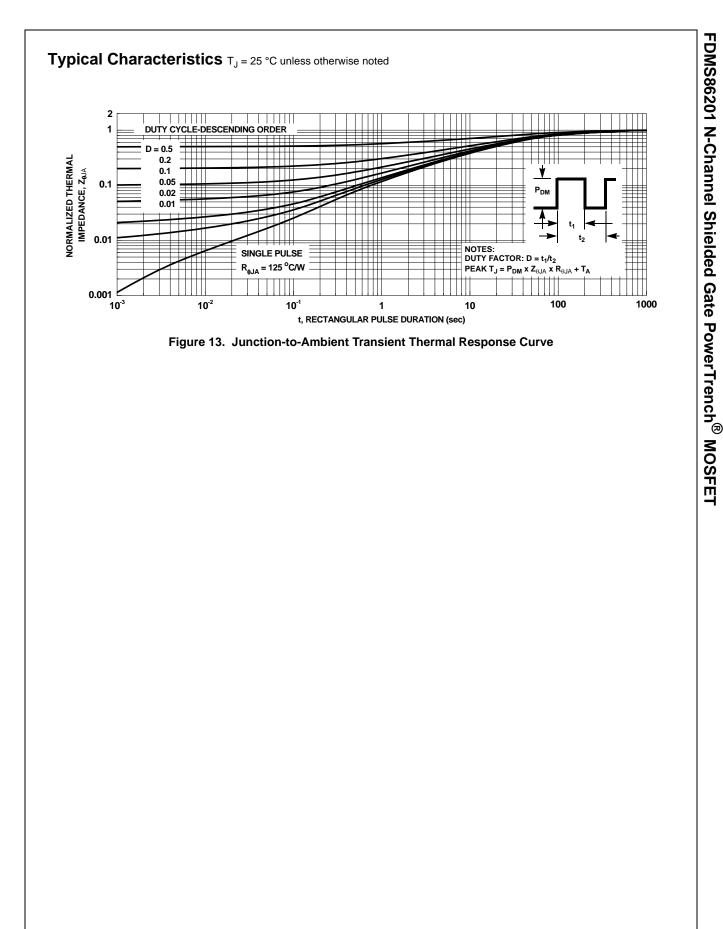


b) 125 °C/W when mounted on a minimum pad of 2 oz copper.





FDMS86201 N-Channel Shielded Gate PowerTrench[®] MOSFET





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